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FQB1P50

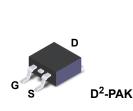
P-Channel QFET[®] MOSFET - 500 V, - 1.5 A, 10.5 Ω

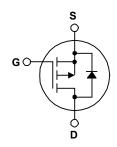
Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 1.5 A, 500 V, $R_{DS(on)}$ = 10.5 Ω (Max.) @ V_{GS} = 10 V, I_{D} = 0.75 A
- Low Gate Charge (Typ. 11 nC)
- Low Crss (Typ. 6.0 pF)
- 100% Avalanche Tested
- RoHS Compliant





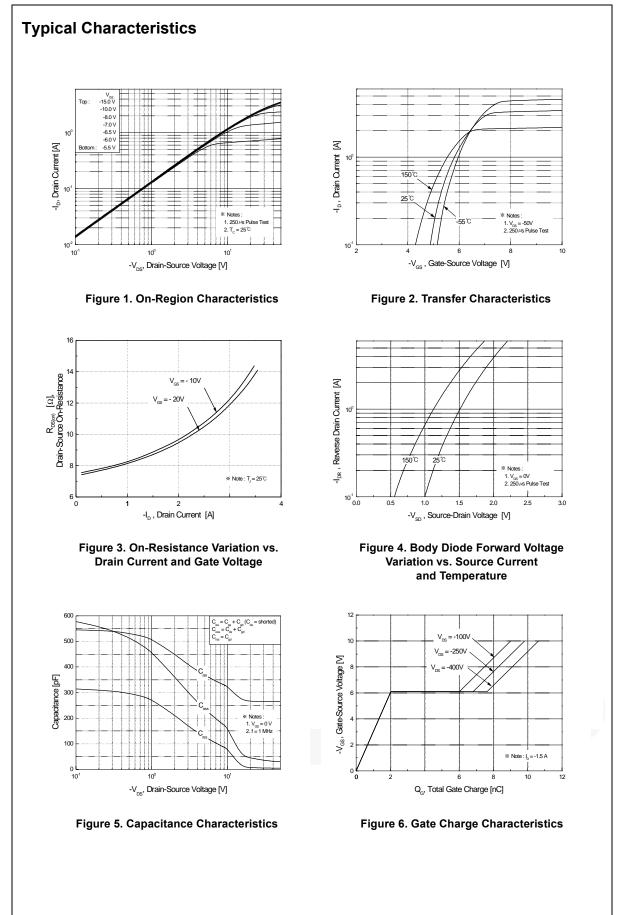
Absolute Maximum Ratings T_C = 25°C unless otherwise noted

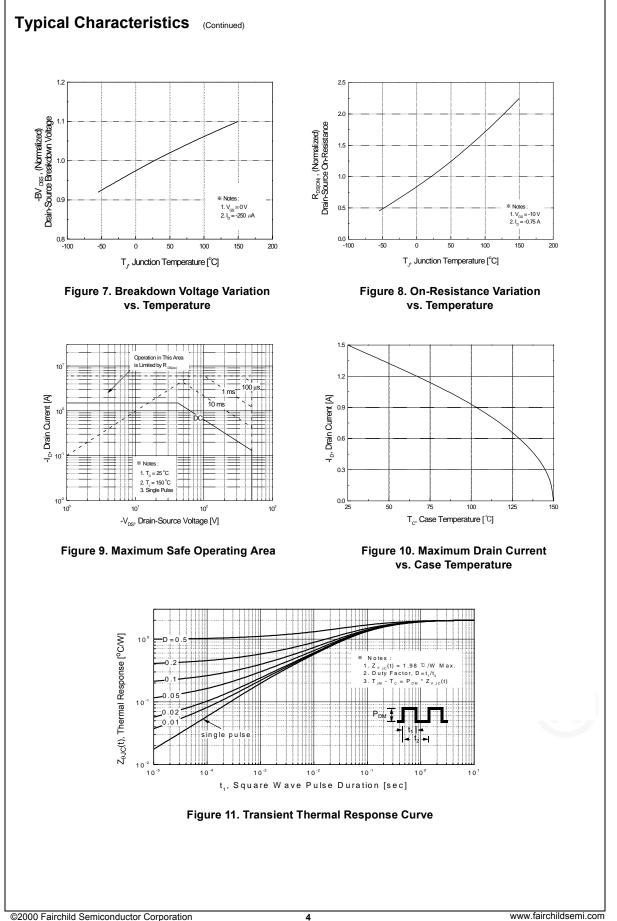
Symbol	Parameter		FQB1P50TM	Unit	
V _{DSS}	Drain-Source Voltage		-500	V	
I _D	Drain Current - Continuous (T _C = 25°	C)	-1.5	A	
	- Continuous (T _C = 100	°C)	-0.95	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	-6.0	A	
V _{GSS}	Gate-Source Voltage	± 30	V		
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	110	mJ	
I _{AR}	Avalanche Current	(Note 1)	-1.5	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	6.3	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns	
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *		3.13	W	
	Power Dissipation ($T_c = 25^{\circ}C$)		63	W	
	- Derate above 25°C		0.51	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

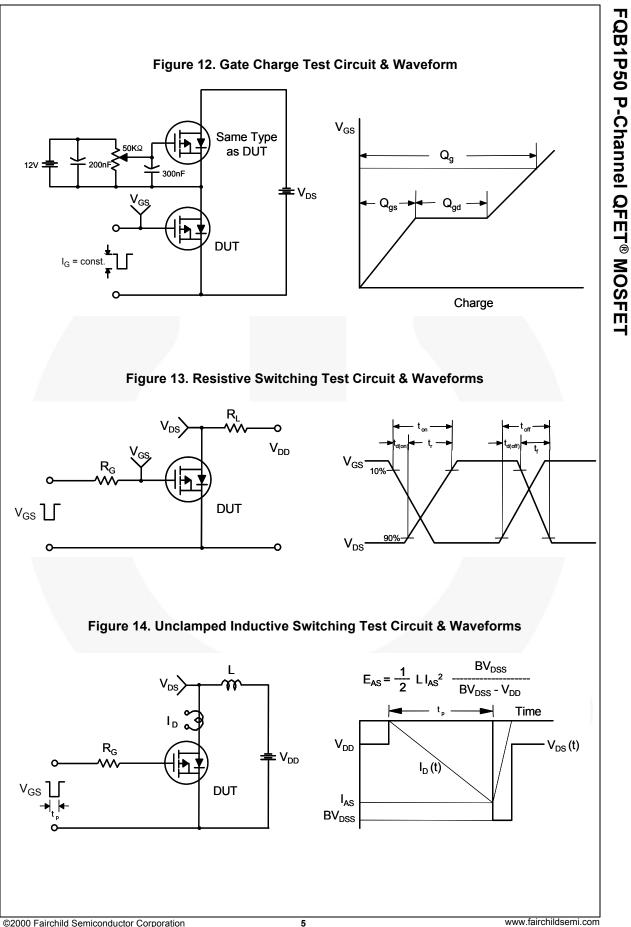
Symbol	Parameter	FQB1P50TM	Unit	
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max	1.98		
D	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W	
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (1 in ² pad of 2 oz copper), Max.	40		

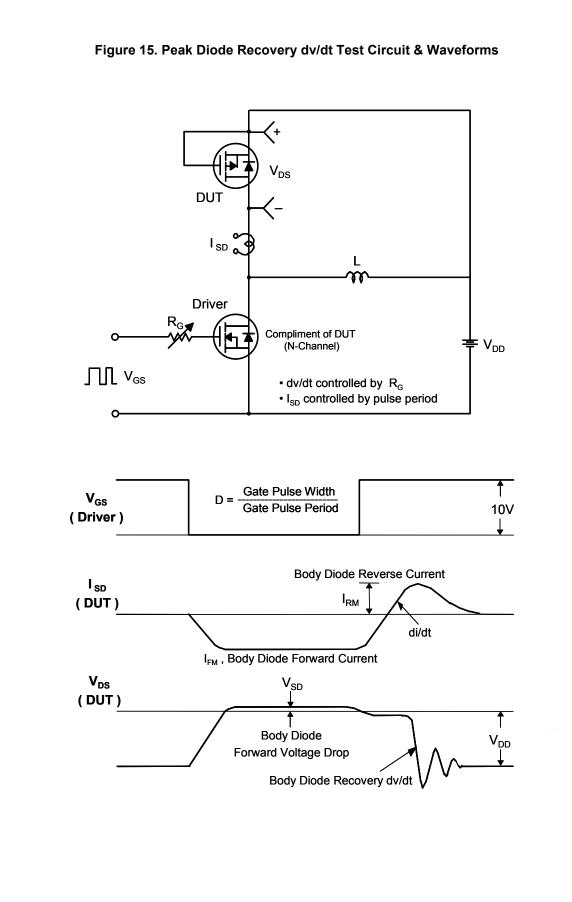
Symbol Off Chara BVDSS BVDSS ATJ COSS SSSF GSSR CONChara	Charac acteristi Drain-Sour Breakdowr Coefficient Zero Gate Gate-Body	Parameter CS rce Breakdown Voltage N Voltage Temperature	、 、			24mi Min	m Typ	Max	800 Unit
Symbol Off Chara BVDSS LBVDSS ATJ CDSS CSSF CSSR COND COND COND	acteristi Drain-Sour Breakdowr Coefficient Zero Gate Gate-Body	Parameter CS rce Breakdown Voltage N Voltage Temperature	e V _{GS}	Test Conditions	6	Min	Тур	Max	Unit
Symbol Off Chara 3VDSS BVDSS ΔTJ C DSS GSSF C DDSR C	acteristi Drain-Sour Breakdowr Coefficient Zero Gate Gate-Body	Parameter CS rce Breakdown Voltage N Voltage Temperature	e V _{GS}	Test Conditions	3	Min	Тур	Max	Unit
ABVDSS E ΔT_J C DSS Z GSSF C GSSR C DN Chara	Drain-Sour Breakdowr Coefficient Zero Gate Gate-Body	rce Breakdown Voltage n Voltage Temperature	、 、	= 0 V, I _D = -250 μA				•	
3VDSS C ΔBVDSS E ΔTJ C DSS Z GSSF C GSSR C Dn Chara	Drain-Sour Breakdowr Coefficient Zero Gate Gate-Body	rce Breakdown Voltage n Voltage Temperature	、 、	= 0 V, I _D = -250 μA					
BV _{DSS} E ΔT _J C DSS Z GSSF C GSSSF C Dn Chara	Breakdowr Coefficient Zero Gate Gate-Body	n Voltage Temperature	、 、	= ο ν, η = 200 μ/		-500			V
ΔTJ C DSS Z GSSF C GSSR C Dn Chara	Coefficient Zero Gate Gate-Body		′ I _D =			-500			
GSSF G GSSR G	Gate-Body	Voltage Drain Current	_	$I_D = -250 \ \mu$ A, Referenced to 25°C			-		V/°C
GSSF G GSSR G	Gate-Body	voltage Drain Current	V _{DS}	$V_{DS} = -500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				-1	μA
GSSR G		Zero Gate Voltage Drain Current		V _{DS} = -400 V, T _C = 125°C				-10	μA
On Chara		Leakage Current, For	rward V _{GS}	= -30 V, $V_{DS} = 0 V$				-100	nA
	Gate-Body	Leakage Current, Rev	verse V _{GS}	= 30 V, V_{DS} = 0 V				100	nA
	otorioti	~~							
V _{GS(th)} G		shold Voltage	Vns	= V _{GS} , I _D = -250 μA		-3.0		-5.0	V
	Static Drai			= -10 V, I _D = -0.75 A			8.0	10.5	Ω
	On-Resista	ince		-				10.5	
9 _{FS} F	Forward Tr	ansconductance	V _{DS}	= -50 V, I _D = -0.75 A	١		1.26		S
Dynamic	Charac	teristics							
C _{iss} Ir	nput Capa	icitance	Vns	$V_{DS} = -25 V, V_{GS} = 0 V,$ f = 1.0 MHz			270	350	pF
C _{oss} C	Output Cap	oacitance					40	50	pF
C _{rss} F	Reverse Ti	ransfer Capacitance					6.0	8.0	pF
Switching	ɑ Chara	cteristics							
	Turn-On D		V	- 250 \/ - 15/			9.0	30	ns
t _r T	Turn-On Ri	ise Time		= -250 V, I _D = -1.5 A = 25 Ω	λ,		25	60	ns
t _{d(off)} T	Turn-Off D	elay Time	KG .	- 20 32			27	65	ns
^t f T	Turn-Off Fa	all Time			(Note 4)		30	70	ns
Q _g т	Total Gate	Charge	Vns	= -400 V, I _D = -1.5 A	۸.		11	14	nC
Q _{gs} G	Gate-Sour	ce Charge		= -10 V	-,		2.0		nC
Q _{gd} G	Gate-Drain	Charge		(Note 4)			5.6		nC
		-							
-		ode Characteristi		-	S		,		
		Continuous Drain-Sou						-1.5	A
		Pulsed Drain-Source D						-6.0	A
	Drain-Sour	ce Diode Forward Volt	-	= 0 V, I _S = -1.5 A				-5.0	V
<u>^</u>		ecovery Time		= 0 V, I _S = -1.5 A,			200		ns
	Reverse R	ecovery Charge	dl _F /	′ dt = 100 A/μs			0.7		μC
otes:		th limited by maximum junctio							



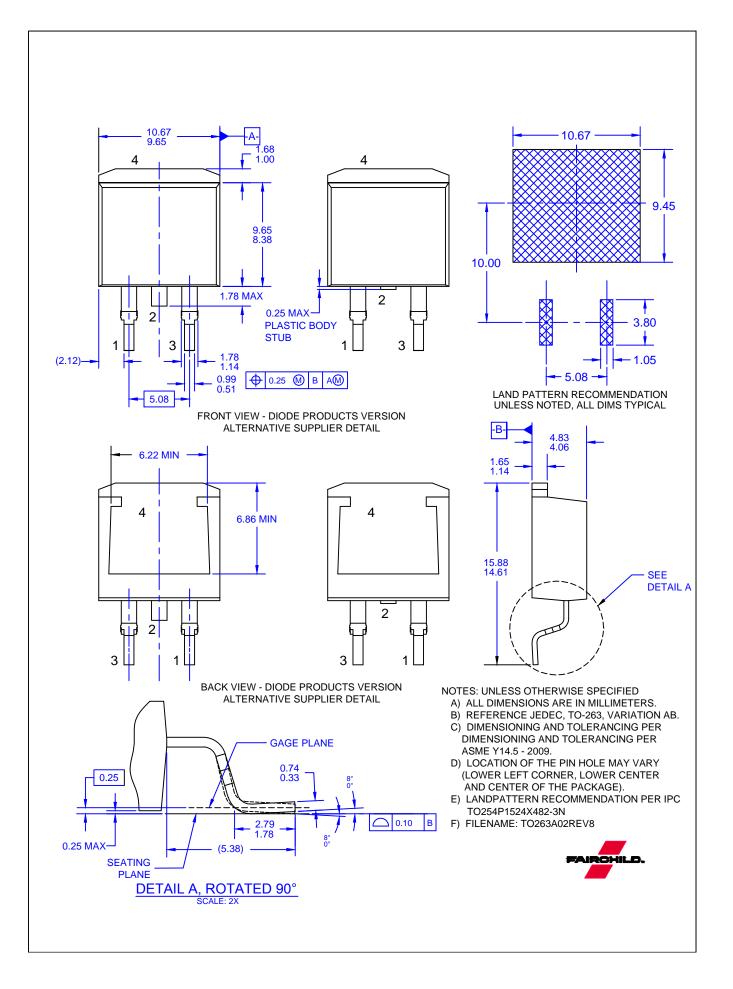


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